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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

2 0 0 0 0 0	
Product Status	Active
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	I ² C, LINbus, SIO, SSU, UART/USART
Peripherals	POR, Voltage Detect, WDT
Number of I/O	41
Program Memory Size	48KB (48K x 8)
Program Memory Type	FLASH
EEPROM Size	•
RAM Size	2.5K x 8
Voltage - Supply (Vcc/Vdd)	2.2V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	52-LQFP
Supplier Device Package	52-LQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21257sdfp-v2

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Figure 1.3 Type Number, Memory Size, and Package of R8C/25 Group



1.6 Pin Functions

Table 1.5 lists Pin Functions.

Table 1.5Pin Functions

Туре	Symbol	I/O Type	Description
Power supply input	VCC, VSS	I	Apply 2.2 V to 5.5 V to the VCC pin. Apply 0 V to the VSS pin.
Analog power	AVCC, AVSS	I	Power supply for the A/D converter.
supply input			Connect a capacitor between AVCC and AVSS.
Reset input	RESET	I	Input "L" on this pin resets the MCU.
MODE	MODE	I	Connect this pin to VCC via a resistor.
XIN clock input	XIN	I	These pins are provided for XIN clock generation circuit I/O. Connect a ceramic resonator or a crystal oscillator between
XIN clock output	XOUT	0	the XIN and XOUT pins. To use an external clock, input it to the XIN pin and leave the XOUT pin open.
XCIN clock input	XCIN	I	These pins are provided for XCIN clock generation circuit I/O. Connect a crystal oscillator between the XCIN and XCOUT
XCIN clock output	XCOUT	0	pins. To use an external clock, input it to the XCIN pin and leave the XCOUT pin open.
INT interrupt input	INT0 to INT3	I	INT interrupt input pins. INT0 is timer RD input pin. INT1 is timer RA input pin.
Key input interrupt	KI0 to KI3	I	Key input interrupt input pins
Timer RA	TRAIO	I/O	Timer RA I/O pin
	TRAO	0	Timer RA output pin
Timer RB	TRBO	0	Timer RB output pin
Timer RD	TRDIOA0, TRDIOA1, TRDIOB0, TRDIOB1, TRDIOC0, TRDIOC1, TRDIOD0, TRDIOD1	I/O	Timer RD I/O ports
	TRDCLK	I	External clock input pin
Timer RE	TREO	0	Divided clock output pin
Serial interface	CLK0, CLK1	I/O	Transfer clock I/O pin
	RXD0, RXD1	I	Serial data input pins
	TXD0, TXD1	0	Serial data output pins
I ² C bus interface	SCL	I/O	Clock I/O pin
	SDA	I/O	Data I/O pin
Clock synchronous	SSI	I/O	Data I/O pin
serial I/O with chip	SCS	I/O	Chip-select signal I/O pin
select	SSCK	I/O	Clock I/O pin
	SSO	I/O	Data I/O pin
Reference voltage input	VREF	I	Reference voltage input pin to A/D converter
A/D converter	AN0 to AN11	I	Analog input pins to A/D converter
I/O port	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0, P3_1, P3_3 to P3_5, P3_7, P4_3 to P4_5, P6_0 to P6_7	I/O	CMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. Any port set to input can be set to use a pull-up resistor or not by a program. P2_0 to P2_7 also function as LED drive ports.
Input port	P4_2, P4_6, P4_7	I	Input-only ports
: Input O: Outp			

I: Input O: Output I/O: Input and output



			I/O Pin Functions for of Peripheral Modules					
Pin Number	Control Pin	Port	Interrupt	Timer	Serial Interface	Clock Synchronous Serial I/O with Chip Select	I ² C bus Interface	A/D Converter
2		P3_5				SSCK	SCL	
3		P3_3				SSI		
4		 P3_4				SCS	SDA	
5	MODE						02/1	
6	XCIN	P4_3						
7	XCOUT	P4_4						
8	RESET							
9	XOUT	P4_7						
10	VSS/AVSS							
11	XIN	P4_6						
12	VCC/AVCC							
13		P2_7		TRDIOD1				
14		 P26		TRDIOC1				
15		P2_5		TRDIOB1				
16		P2_4		TRDIOA1				
17		P2_3		TRDIOD0				
18		P2_2		TRDIOC0				
19		P2_1		TRDIOB0				
20		P2_0		TRDIOA0/TRDCLK				
21		P1_7	INT1	TRAIO				
22		P1_6			CLK0			
23		P1_5	(INT1) ⁽¹⁾	(TRAIO) ⁽¹⁾	RXD0			
24		 P1_4		(TXD0			
25		 P1_3	KI3					AN11
27		P4_5	INTO	INTO				
28		P6_6	INT2	INTO	TXD1			
29		P6_7	INT2		RXD1			
30		P1_2	KI2		10.01			AN10
31		P1_1	KI2 KI1					AN9
32		P1_0	KII KIO					AN8
33		P3_1	KIU	TRBO				
34		P3_0		TRAO				
35		P6_5		11010	CLK1			
36		P6_4			OLIVI			
37		P6_3						
38		P0_7						AN0
41		P0_6						AN1
42		P0_5						AN2
43		P0_4						AN3
44	VREF	P4_2						
45		P6_0		TREO				
46		P6_2		_				
47		P6_1						
48		P0_3						AN4
49		P0_2						AN5
50		P0_1						AN6
51		P0_0						AN7
52		 P3_7				SSO		
NOTE:			•					

 Table 1.6
 Pin Name Information by Pin Number

NOTE:

1. Can be assigned to the pin in parentheses by a program.

Address	Pagistar	Symbol	After report
Address	Register	Symbol	After reset
0040h			
0041h			
0042h			
0043h			
0044h			
0045h			
0046h			
0040h			
		TODALO	2000000
0048h	Timer RD0 Interrupt Control Register	TRDOIC	XXXXX000b
0049h	Timer RD1 Interrupt Control Register	TRD1IC	XXXXX000b
004Ah	Timer RE Interrupt Control Register	TREIC	XXXXX000b
004Bh			
004Ch			
004Dh	Key Input Interrupt Control Register	KUPIC	XXXXX000b
004Eh	A/D Conversion Interrupt Control Register	ADIC	XXXXX000b
004Fh	SSU/IIC Interrupt Control Register ⁽²⁾	SSUIC / IICIC	XXXXX000b
		000107 11010	XXXXX0000D
0050h		00710	20000000
0051h	UART0 Transmit Interrupt Control Register	SOTIC	XXXXX000b
0052h	UART0 Receive Interrupt Control Register	SORIC	XXXXX000b
0053h	UART1 Transmit Interrupt Control Register	S1TIC	XXXXX000b
0054h	UART1 Receive Interrupt Control Register	S1RIC	XXXXX000b
0055h	INT2 Interrupt Control Register	INT2IC	XX00X000b
0056h	Timer RA Interrupt Control Register	TRAIC	XXXXX000b
0057h			
	Times DD Interrupt Control Degister	TODIC	XXXXXX000h
0058h	Timer RB Interrupt Control Register	TRBIC	XXXXX000b
0059h	INT1 Interrupt Control Register	INT1IC	XX00X000b
005Ah	INT3 Interrupt Control Register	INT3IC	XX00X000b
005Bh			
005Ch			
005Dh	INT0 Interrupt Control Register	INTOIC	XX00X000b
005Eh			
005Fh			
0060h			
0061h			
0062h			
0063h			
0064h			
0065h			
0066h			
0067h			
0068h			
0069h			
006Ah			
006Bh			
006Ch			
006Dh			
006Eh			
006Fh			
0070h		1	
0071h		İ	
0072h			
0072h			
0073h			
4			ļ
0075h			
0076h			
0077h			
0078h			
0079h			
007Ah			
007Bh		1	
007Ch			
007Dh			
007Dh			
4			ļ
007Fh			

Table 4.2	SFR Information (2) ⁽¹⁾
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X: Undefined
NOTES:

The blank regions are reserved. Do not access locations in these regions.
Selected by the IICSEL bit in the PMR register.

5. Electrical Characteristics

The electrical characteristics of N version (Topr = -20 to 85° C) and D version (Topr = -40 to 85° C) are listed below.

Please contact Renesas Technology sales offices for the electrical characteristics in the Y version (Topr = -20 to 105° C).

Table 5.1 Absolute Maximum Ratings

Symbol	Parameter	Condition	Rated Value	Unit
Vcc/AVcc	Supply voltage		-0.3 to 6.5	V
VI	Input voltage		-0.3 to Vcc + 0.3	V
Vo	Output voltage		-0.3 to Vcc + 0.3	V
Pd	Power dissipation	$T_{opr} = 25^{\circ}C$	500 ⁽¹⁾	mW
Topr	Operating ambient temperature		-20 to 85 (N version) / -40 to 85 (D version)	°C
Tstg	Storage temperature		-65 to 150	°C

NOTE:

1. 300 mW for the PTLG0064JA-A package.

Cumb ol	Parameter		Conditions	Standard			Unit
Symbol		Parameter	Conditions	Min.	Тур.	Max.	Unit
-	Resolution		Vref = AVCC	-	-	10	Bit
-	Absolute	10-bit mode	ϕ AD = 10 MHz, Vref = AVCC = 5.0 V	-	-	±3	LSB
	accuracy	8-bit mode	ϕ AD = 10 MHz, Vref = AVCC = 5.0 V	-	-	±2	LSB
		10-bit mode	ϕ AD = 10 MHz, Vref = AVCC = 3.3 V	-	-	±5	LSB
		8-bit mode	ϕ AD = 10 MHz, Vref = AVCC = 3.3 V	-	-	±2	LSB
		10-bit mode	ϕ AD = 5 MHz, Vref = AVCC = 2.2 V	-	-	±5	LSB
		8-bit mode	ϕ AD = 5 MHz, Vref = AVCC = 2.2 V	-	-	±2	LSB
Rladder	Resistor ladder		Vref = AVCC	10	-	40	kΩ
tconv	Conversion time	10-bit mode	ϕ AD = 10 MHz, Vref = AVCC = 5.0 V	3.3	-	-	μs
		8-bit mode	ϕ AD = 10 MHz, Vref = AVCC = 5.0 V	2.8	-	-	μs
Vref	Reference voltag	e		2.2	-	AVcc	V
Via	Analog input volta	age ⁽²⁾		0	-	AVcc	V
-	A/D operating	Without sample and hold	Vref = AVcc = 2.7 to 5.5 V	0.25	-	10	MHz
	clock frequency	With sample and hold	Vref = AVcc = 2.7 to 5.5 V	1	-	10	MHz
		Without sample and hold	Vref = AVcc = 2.2 to 5.5 V	0.25	-	5	MHz
		With sample and hold	Vref = AVcc = 2.2 to 5.5 V	1	-	5	MHz

Table 5.3 A/D Converter Characteristics

NOTES:

1. AVcc = 2.2 to 5.5 V at T_{opr} = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.

2. When the analog input voltage is over the reference voltage, the A/D conversion result will be 3FFh in 10-bit mode and FFh in 8-bit mode.



Figure 5.1 Ports P0 to P4, P6 Timing Measurement Circuit

Cumhal	Deremeter	Condition		Standard		Unit
Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
fOCO40M	High-speed on-chip oscillator frequency temperature • supply voltage dependence		39.2	40	40.8	MHz
			38.8	40	40.8	MHz
		Vcc = 4.5 to 5.5 V -40°C ≤ Topr ≤ 85°C	38.4	40	40.8	MHz
		Vcc = 3.0 to 5.5 V -20°C \leq Topr \leq 85°C ⁽²⁾	38.8	40	41.2	MHz
		$\label{eq:Vcc} \begin{array}{l} Vcc = 3.0 \text{ to } 5.5 \text{ V} \\ -40^{\circ}C \leq T_{opr} \leq 85^{\circ}C^{(2)} \end{array}$		41.6	MHz	
		Vcc = 2.7 to 5.5 V 38 40 -20°C \leq Topr \leq 85°C ⁽²⁾ 40	40	42	MHz	
		$V_{CC} = 2.7 \text{ to } 5.5 \text{ V}$ -40°C $\leq T_{OPT} \leq 85^{\circ}C^{(2)}$	37.6	40	42.4	MHz
		$V_{CC} = 2.2 \text{ to } 5.5 \text{ V}$ -20°C \leq Topr \leq 85°C ⁽³⁾	35.2	40	44.8	MHz
		$V_{CC} = 2.2 \text{ to } 5.5 \text{ V}$ -40°C \leq Topr \leq 85°C ⁽³⁾	34	40	40.8 40.8 41.2 41.6 42 42.4 42.4 44.8 46	MHz
	High-speed on-chip oscillator frequency when	Vcc = 5.0 V, Topr = 25°C	-	36.864		MHz
	correction value in FRA7 register is written to FRA1 register ⁽⁴⁾	Vcc = 3.0 to 5.5 V -20°C ≤ Topr ≤ 85°C	-3%	-	3%	%
-	Value in FRA1 register after reset		08h	-	F7h	-
-	Oscillation frequency adjustment unit of high- speed on-chip oscillator	Adjust FRA1 register (value after reset) to -1	-	+0.3	-	MHz
-	Oscillation stability time		-	10	100	μS
-	Self power consumption at oscillation	VCC = 5.0 V, Topr = 25°C	-	400	-	μA

Table 5.10	High-speed On-Chip Oscillator Circuit Electrical Characteristics
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NOTES:

1. Vcc = 2.2 to 5.5 V, $T_{opr} = -20$ to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.

2. Standard values when the FRA1 register value after reset is assumed.

3. Standard values when the corrected value of the FRA6 register has been written to the FRA1 register.

4. This enables the setting errors of bit rates such as 9600 bps and 38400 bps to be 0% when the serial interface is used in UART mode.

Table 5.11 Low-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
Symbol	Falameter	Min. Typ. M	Max.	Unit		
fOCO-S	Low-speed on-chip oscillator frequency		30	125	250	kHz
-	Oscillation stability time		-	10	100	μS
-	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	-	15	-	μA

NOTE:

1. Vcc = 2.2 to 5.5 V, Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.

Table 5.12 Power Supply Circuit Timing Characteristics

Symbol	Parameter	Condition	;	Unit		
Symbol	Falanetei	Condition	Min.	Тур.	Max.	Unit
td(P-R)	Time for internal power supply stabilization during power-on ⁽²⁾		1	-	2000	μS
td(R-S)	STOP exit time ⁽³⁾		-	-	150	μS

NOTES:

1. The measurement condition is Vcc = 2.2 to 5.5 V and $T_{opr} = 25^{\circ}C$.

2. Waiting time until the internal power supply generation circuit stabilizes during power-on.

3. Time until system clock supply starts after the interrupt is acknowledged to exit stop mode.



Symbol	Doromoto	Parameter			Standard			
Symbol	Paramete	ſ	Conditions	Min.	Тур.	Max.		
tsucyc	SSCK clock cycle time	e		4	_	-	tCYC ⁽²⁾	
tнı	SSCK clock "H" width			0.4	I	0.6	tsucyc	
tlo	SSCK clock "L" width			0.4	-	0.6	tsucyc	
trise	SSCK clock rising	Master		-	-	1	tCYC ⁽²⁾	
time	time	Slave		-	-	1	μs	
t FALL	SSCK clock falling	Master		-	-	1	tCYC ⁽²⁾	
	time	Slave		-	I	1	μs	
ts∪	SSO, SSI data input s	etup time		100	-	-	ns	
tн	SSO, SSI data input h	old time		1	-	-	tCYC ⁽²⁾	
tlead	SCS setup time	Slave		1tcyc + 50	-	_	ns	
tlag	SCS hold time	Slave		1tcyc + 50	_	_	ns	
top	SSO, SSI data output	delay time		-	-	1	tCYC ⁽²⁾	
tsa	SSI slave access time	;	$2.7 \text{ V} \leq \text{Vcc} \leq 5.5 \text{ V}$	_	Ī	1.5tcyc + 100	ns	
			$2.2 \text{ V} \leq \text{Vcc} < 2.7 \text{ V}$	-	_	1.5tcyc + 200	ns	
tOR	SSI slave out open tin	ne	$2.7~V \leq Vcc \leq 5.5~V$	-	_	1.5tcyc + 100	ns	
			$2.2 \text{ V} \leq \text{Vcc} < 2.7 \text{ V}$	-	_	1.5tcyc + 200	ns	

Table 5.13 Timing Requirements of Clock Synchronous Serial I/O with Chip Select⁽¹⁾

NOTES:

1. Vcc = 2.2 to 5.5 V, Vss = 0 V at Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified. 2. $1t_{CYC} = 1/f1(s)$



Unit

ns ns ns

ns

ns ns ns

ns

ns

ns

ns

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	initing requirements of 1 0 be					
Cumbol	Parameter	Condition	Standa	Standard		
Symbol	Parameter	Condition	Min.	Тур.	Max.	
tSCL	SCL input cycle time		12tcyc + 600 ⁽²⁾	-	-	
t SCLH	SCL input "H" width		3tcyc + 300 ⁽²⁾	-	-	
tSCLL	SCL input "L" width		5tcyc + 500 ⁽²⁾	-	-	
tsf	SCL, SDA input fall time		-	-	300	
tSP	SCL, SDA input spike pulse rejection time		-	-	1tcyc ⁽²⁾	
t BUF	SDA input bus-free time		5tcyc ⁽²⁾	-	-	
t STAH	Start condition input hold time		3tcyc ⁽²⁾	-	-	
t STAS	Retransmit start condition input setup time		3tcyc ⁽²⁾	-	-	

Table 5.14	Timing Requirements of I ² C bus Interface ⁽¹⁾
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Stop condition input setup time

Data input setup time

Data input hold time

tSDAH NOTES:

tSTOP

tSDAS

1. Vcc = 2.2 to 5.5 V, Vss = 0 V and Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.

3tcyc⁽²⁾

1tcyc + 20⁽²⁾

0

_

_

2. 1tcyc = 1/f1(s)





Symbol	Do	Parameter		Condition		Standard				Unit
Symbol	Fai	ameter	Conditio	41	Min.	Тур.	Max.	Unit		
Vон	Output "H" voltage	Except P2_0 to P2_7,	Iон = -5 mA		Vcc - 2.0	-	Vcc	V		
		XOUT	Іон = -200 μА		Vcc - 0.5	-	Vcc	V		
		P2_0 to P2_7	Drive capacity HIGH	Iон = -20 mA	Vcc - 2.0	-	Vcc	V		
			Drive capacity LOW	Іон = -5 mA	Vcc - 2.0	-	Vcc	V		
		XOUT	Drive capacity HIGH	Іон = -1 mA	Vcc - 2.0	-	Vcc	V		
			Drive capacity LOW	Іон = -500 μА	Vcc - 2.0	-	Vcc	V		
Vol	Output "L" voltage	Except P2_0 to P2_7,	IOL = 5 mA	•	-	-	2.0	V		
		XOUT	IoL = 200 μA		-	-	0.45	V		
		P2_0 to P2_7	Drive capacity HIGH	IoL = 20 mA	-	-	2.0	V		
			Drive capacity LOW	IoL = 5 mA	-	-	2.0	V		
		XOUT	Drive capacity HIGH	IoL = 1 mA	-	-	2.0	V		
			Drive capacity LOW	IoL = 500 μA	-	-	2.0	V		
Vt+-Vt-	Hysteresis	INT0, INT1, INT2, INT3, KI0, KI1, KI2, KI3, TRAIO, RXD0, RXD1, CLK0, CLK1, SSI, SCL, SDA, SSO			0.1	0.5	_	V		
		RESET			0.1	1.0	-	V		
Ін	Input "H" current		VI = 5 V, Vcc = 5V		_	_	5.0	μA		
lı∟	Input "L" current		VI = 0 V, Vcc = 5V		-	-	-5.0	μA		
Rpullup	Pull-up resistance		VI = 0 V, Vcc = 5V		30	50	167	kΩ		
Rfxin	Feedback resistance	XIN			-	1.0	-	MΩ		
Rfxcin	Feedback resistance	XCIN			-	18	-	MΩ		
Vram	RAM hold voltage	•	During stop mode		1.8	_	-	V		

Table 5.15	Electrical	Characteristics	(1)	[Vcc = 5 V]
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NOTE:

1. Vcc = 4.2 to 5.5 V at Topr = -20 to 85°C (N version) / -40 to 85°C (D version), f(XIN) = 20 MHz, unless otherwise specified.

Table 5.17Electrical Characteristics (3) [Vcc = 5 V]
(Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter		Condition		Standard		Standard		
Symbol	Parameter		Condition	Min.	Тур.	Max.	Unit		
Icc	Power supply current (Vcc = 3.3 to 5.5 V) Single-chip mode, output pins are open, other pins	Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	-	25	75	μΑ		
	are Vss		XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	-	23	60	μΑ		
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (high drive) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	-	4.0	_	μΑ		
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (low drive) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	-	2.2	-	μΑ		
		Increase during	Without sample & hold	-	2.6	-	mA		
		A/D converter operation	With sample & hold	-	1.6	-	mA		
		Stop mode	XIN clock off, $T_{opr} = 25^{\circ}C$ High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	_	0.8	3.0	μΑ		
			XIN clock off, $T_{opr} = 85^{\circ}C$ High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	-	1.2	_	μΑ		

Table 5.23Electrical Characteristics (4) [Vcc = 3 V]
(Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter		Condition	5	Standar	d	Unit
	Parameter			Min.	Тур.	Max.	Unit
Icc	Power supply current (Vcc = 2.7 to 3.3 V) Single-chip mode, output pins are open,	High-speed clock mode	XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	-	6	-	mA
	other pins are Vss		XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	2	_	mA
		High-speed on- chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz No division	_	5	9	mA
			XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	2	_	mA
		Low-speed on- chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR47 = 1	_	130	300	μA
		Low-speed clock mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz FMR47 = 1	_	130	300	μA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz Program operation on RAM Flash memory off, FMSTP = 1	_	30	-	μA
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	_	25	70	μA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	_	23	55	μA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (high drive) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	-	3.8	-	μA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (low drive) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	_	2.0	_	μA
		Increase during	Without sample & hold	-	0.9	-	mA
		A/D converter operation	With sample & hold	-	0.5	-	mA
		Stop mode	XIN clock off, $T_{opr} = 25^{\circ}C$ High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	_	0.7	3.0	μA
			VOLUT = VOLUT = VOLUT = 0XIN clock off, $T_{opr} = 85^{\circ}$ CHigh-speed on-chip oscillator offLow-speed on-chip oscillator offCM10 = 1Peripheral clock offVCA27 = VCA26 = VCA25 = 0	_	1.1		μA

Timing requirements (Unless Otherwise Specified: Vcc = 3 V, Vss = 0 V at Topr = 25°C) [Vcc = 3 V]

Table 5.24 XIN Input, XCIN Input

Symbol	Parameter	Standard	Unit	
Symbol	Falanielei	Min.	Max.	Unit
tc(XIN)	XIN input cycle time	100	-	ns
twh(xin)	XIN input "H" width	40	-	ns
twl(XIN)	XIN input "L" width	40	-	ns
tc(XCIN)	XCIN input cycle time	14	-	μs
tWH(XCIN)	XCIN input "H" width	7	-	μs
tWL(XCIN)	XCIN input "L" width	7	-	μS



Figure 5.12 XIN Input and XCIN Input Timing Diagram when Vcc = 3 V

Table 5.25 TRAIO Input

Symbol	Parameter	Standard		Unit
Symbol	Falanielei		Max.	Onit
tc(TRAIO)	TRAIO input cycle time	300	-	ns
twh(traio)	TRAIO input "H" width	120	-	ns
twl(traio)	TRAIO input "L" width	120	-	ns



Figure 5.13 TRAIO Input Timing Diagram when Vcc = 3 V

Symbol	Doro	motor	Cond	lition	S	tandard		Unit
Symbol	Para	ameter	Cond	lition	Min. Typ.		Max.	Unit
Vон	Output "H" voltage	Except P2_0 to P2_7, XOUT	Iон = -1 mA		Vcc - 0.5	_	Vcc	V
		P2_0 to P2_7	Drive capacity HIGH	Іон = -2 mA	Vcc - 0.5	_	Vcc	V
			Drive capacity LOW	Іон = -1 mA	Vcc - 0.5	-	Vcc	V
		XOUT	Drive capacity HIGH	Іон = -0.1 mA	Vcc - 0.5	_	Vcc	V
			Drive capacity LOW	Іон = -50 μА	Vcc - 0.5	-	Vcc	V
Vol	Output "L" voltage	Except P2_0 to P2_7, XOUT	IoL = 1 mA		-	-	0.5	V
		P2_0 to P2_7	Drive capacity HIGH	IoL = 2 mA	_	_	0.5	V
			Drive capacity LOW	IoL = 1 mA	-	-	0.5	V
		XOUT	Drive capacity HIGH	lo∟ = 0.1 mA	-	-	0.5	V
			Drive capacity LOW	IoL = 50 μA	-	-	0.5	V
VT+-VT-	Hysteresis	INT0, INT1, INT2, INT3, KI0, KI1, KI2, KI3, TRAIO, RXD0, RXD1, CLK0, CLK1, SSI, SCL, SDA, SSO			0.05	0.3	_	V
		RESET			0.05	0.15	-	V
Ін	Input "H" current		VI = 2.2 V		-	_	4.0	μA
lı∟	Input "L" current		VI = 0 V		-	-	-4.0	μA
Rpullup	Pull-up resistance		VI = 0 V		100	200	600	kΩ
Rfxin	Feedback resistance	XIN			-	5	-	MΩ
Rfxcin	Feedback resistance	XCIN			-	35	-	MΩ
Vram	RAM hold voltage		During stop mode	e	1.8	-	-	V

Table 5.28	Electrical Characteristics (5) [Vcc = 2.2 V]

NOTE:

1. Vcc = 2.2 V at T_{opr} = -20 to 85°C (N version) / -40 to 85°C (D version), f(XIN) = 5 MHz, unless otherwise specified.

Timing requirements (Unless Otherwise Specified: Vcc = 2.2 V, Vss = 0 V at Topr = 25°C) [Vcc = 2.2 V]

Table 5.30 XIN Input, XCIN Input

Symbol	Parameter	Standard	Unit	
Symbol	Falanletei	Min.	Max.	Unit
tc(XIN)	XIN input cycle time	200	-	ns
twh(xin)	XIN input "H" width	90	-	ns
twl(XIN)	XIN input "L" width	90	-	ns
tc(XCIN)	XCIN input cycle time	14	-	μs
tWH(XCIN)	XCIN input "H" width	7	-	μs
tWL(XCIN)	XCIN input "L" width	7	_	μS



Figure 5.16 XIN Input and XCIN Input Timing Diagram when Vcc = 2.2 V

Table 5.31 TRAIO Input

Symbol	Parameter	Stan	Unit	
Symbol	Falanielei		Max.	Onit
tc(TRAIO)	TRAIO input cycle time	500	-	ns
twh(traio)	TRAIO input "H" width	200	-	ns
twl(traio)	TRAIO input "L" width	200	-	ns





Package Dimensions

Diagrams showing the latest package dimensions and mounting information are available in the "Packages" section of the Renesas Technology website.





REVISION HISTORY

R8C/24 Group, R8C/25 Group Datasheet

Devi	Dete		Description
Rev.	Date	Page	Summary
0.30	Sep 01, 2005	19	Tabel 4.5 SFR Information(5) revised: • 0118h : Timer RE Second Data Register/Counter Register → Timer RE Second Data Register/Counter Data Register
		20 21	Tabel 4.6 SFR Information(6) revised:• 0145hPOCR0 \rightarrow TRDPOCR0• 0146h, 0147hTRDCNT0 \rightarrow TRD0• 0148h, 0149hGRA0 \rightarrow TRDGRA0• 014Ah, 014BhGRB0 \rightarrow TRDGRB0• 014Ch, 014DhGRC0 \rightarrow TRDGRD0• 014Eh, 014FhGRD0 \rightarrow TRDGRD0• 0155hPOCR1 \rightarrow TRDPOCR1• 0156h, 0157hTRDCNT1 \rightarrow TRDGRA1• 0158h, 0159hGRA1 \rightarrow TRDGRA1• 015Ah, 015BhGRB1 \rightarrow TRDGRE1• 015Ch, 015DhGRC1 \rightarrow TRDGRD1Tabel 4.7 SFR Information(7) revised:• 01B5h: 0100101b \rightarrow 1000000Xb• 01B7h: XX000001b \rightarrow 00000001b• FFFFh: (Note 2) added
		22 to 44	5. Electrical Characteristics added
0.40	Jan 24, 2006	all pages	 "Preliminary" deleted Symbol name "TRDMDR" → "TRDMR", "SSUAIC" → "SSUIC", and "IIC2AIC" → "IICIC" revised Pin name "TCLK" → "TRDCLK" revised
		2	Table 1.1 Functions and Specifications for R8C/24 Group revised
		3	Table 1.2 Functions and Specifications for R8C/25 Group revised
		4	Figure 1.1 Block Diagram; "Peripheral Functions" added, "System Clock Generation" → "System Clock Generator" revised
		5	Table 1.3 Product Information for R8C/24 Group revised
		6	Table 1.4 Product Information for R8C/25 Group revised
		7	Figure 1.4 Pin Assignments (Top View) "TCLK" \rightarrow "TRDCLK" revised
		8	Table 1.5 Pin Functions "TCLK" \rightarrow "TRDCLK" revised
		9	Table 1.6 Pin Name Information by Pin Number; "TCLK" → "TRDCLK" revised
		10	Figure 2.1 CPU Registers; "Reserved Area" → "Reserved Bit" revised
		12	2.8.10 Reserved Area; "Reserved Area" → "Reserved bit" revised
		13	Figure 3.1 Memory Map of R8C/24 Group; "Program area" \rightarrow "program ROM" revised
		14	3.2 R8C/25 Group, Figure 3.2 Memory Map of R8C/25 Group; "Data area" \rightarrow "data flash", "Program area" \rightarrow "program ROM" revised

REVISION HISTORY

R8C/24 Group, R8C/25 Group Datasheet

Rev.	Date	Description	
		Page	Summary
0.40	Jan 24, 2006	15	Table 4.1 SFR Information(1); 0024h: "TBD" → "When shipping" NOTES 3 and 4 revised
		19	 Table 4.5 SFR Information (5); 0118h: "Timer RE Second Data Register" → "Timer RE Second Data Register / Counter Data Register" 0119h: "Timer RE Minute Data Register" → "Timer RE Minute Data Register / Compare Data Register" 0138h: "TRDMDR" → "TRDMR" 013Bh: "Timer RD Output Master Enable Register" → "Timer RD Output Master Enable Register 1"
		22	Table 5.1 Absolute Maximum Ratings; "Vcc" → "Vcc/AVcc" revised
			Table 5.2 Recommended Operating Conditions revised
		23	Table 5.3 A/D Converter Characteristics revised
		24	Table 5.4 Flash Memory (Program ROM) Electrical Characteristics revised
		25	Table 5.5 Flash Memory (Data flash Block A, Block B) Electrical revised
		26	Table 5.6 Voltage Detection 0 Circuit Electrical Characteristics revisedTable 5.7 Voltage Detection 1 Circuit Electrical Characteristics revisedTable 5.8 Voltage Detection 2 Circuit Electrical Characteristics revised
		28	Table 5.11 High-speed On-Chip Oscillator Circuit Electrical Characteristics revised Table 5.12 Low-speed On-Chip Oscillator Circuit Electrical Characteristics revised Table 5.13 Power Supply Circuit Timing Characteristics revised
		29	Table 5.14 Timing Requirements of Clock Synchronous Serial I/O with Chip Select revised
		33	Table 5.15 Timing Requirements of I ² C bus Interface NOTE1 revised
		34	Table 5.16 Electrical Characteristics (1) [Vcc = 5 V] revised
		35	Table 5.17 Electrical Characteristics (2) [Vcc = 5 V] revised
		36	Table 5.18 XIN Input, XCIN Input revised
		37	Table 5.20 Serial Interface revised
		38	Table 5.22 Electrical Characteristics (3) [Vcc = 3 V] revised
		39	Table 5.23 Electrical Characteristics (4) [Vcc = 3 V] revised
		40	Table 5.24 XIN Input, XCIN Input revised
		41	Table 5.26 Serial Interface revised
		42	Table 5.28 Electrical Characteristics (5) $[Vcc = 2.2 V]$ revised
		43	Table 5.29 Electrical Characteristics (6) [Vcc = 2.2 V] revised
		44	Table 5.30 XIN Input, XCIN Input revised Table 5.31 TRAIO Input, INT1 Input revised
		45	Table 5.32 Serial Interface revised Table 5.33 External Interrupt INTi (i = 0, 2, 3) Input

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